## Supertex inc.

# N-Channel Depletion-Mode Vertical DMOS FETs

#### **Ordering Information**

BV <sub>DSX</sub> /	R <sub>DS(ON)</sub>	I <sub>DSS</sub> (min)	Order Number / Package		
BV <sub>DGX</sub>	(max)		TO-243AA*	Die**	
350V	10Ω	200mA	DN3535N8	DN3535NW	

Product marking for TO-243AA:

DN5S\*

Where \*= 2-week alpha date code

#### **Features**

- ☐ High input impedance
- Low input capacitance
- Fast switching speeds
- Low on resistance
- Free from secondary breakdown
- Low input and output leakage

#### **Applications**

- Normally-on switches
- Solid state relays
- Converters
- Linear amplifiers
- Constant current sources
- Power supply circuits
- □ Telecom

#### **Absolute Maximum Ratings**

Drain-to-Source Voltage	$BV_{DSX}$
Drain-to-Gate Voltage	$BV_{DGX}$
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	55°C to +150°C
Soldering Temperature*	300°C

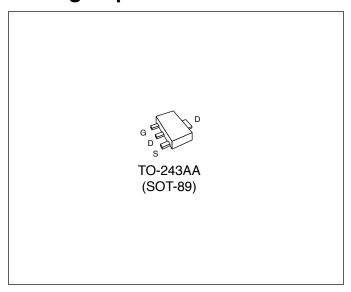
<sup>\*</sup> Distance of 1.6 mm from case for 10 seconds.

#### **Advanced DMOS Technology**

These low threshold depletion-mode (normally-on) transistors utilize an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

#### **Package Option**



<sup>\*</sup> Same as SOT-89. Products shipped on 2000 piece carrier tape reels.

<sup>\*\*</sup> Die in wafer form

#### **Thermal Characteristics**

Package	I <sub>D</sub> (continuous)*	I <sub>D</sub> (pulsed)	Power Dissipation @ T <sub>A</sub> = 25°C	θ <sub>jc</sub> °C/W	θ <sub>ja</sub> °C/W	I <sub>DR</sub> *	I <sub>DRM</sub>
TO-243AA	230mA	500mA	1.6W <sup>†</sup>	15	78 <sup>†</sup>	230mA	500mA

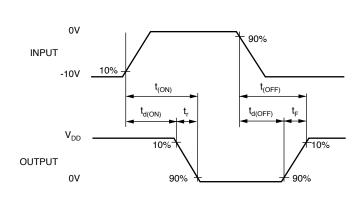
#### Electrical Characteristics (@ 25°C unless otherwise specified)

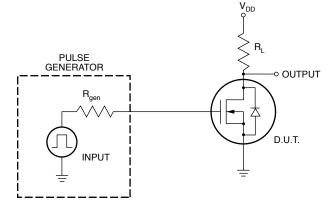
Symbol	Parameter	Min	Тур	Max	Unit	Conditions		
BV <sub>DSX</sub>	Drain-to-Souce Breakdown Voltage	350			٧	$V_{GS} = -5.0V, I_{D} = 1.0\mu A$		
V <sub>GS(OFF)</sub>	Gate-to-Source OFF Voltage	-1.5		-3.5	٧	$V_{DS} = 15V, I_{D} = 10\mu A$		
$\Delta V_{\text{GS(OFF)}}$	Change in V <sub>GS(OFF)</sub> with Temperature			4.5	mV/°C	$V_{DS} = 15V, I_{D} = 10\mu A$		
I <sub>GSS</sub>	Gate Body Leakage Current			100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
I <sub>D(OFF)</sub>	Drain-to-Source Leakage Current			1.0	μΑ	$V_{GS} = -5.0V$ , $V_{DS} = Max$ Rating		
				1.0	mA	$V_{GS} = -5.0V, V_{DS} = 0.8 \text{ Max Rating} $ $T_A = 125^{\circ}\text{C}$		
I <sub>DSS</sub>	Saturated Drain-to-Source Current	200			mA	$V_{GS} = 0V, V_{DS} = 15V$		
R <sub>DS(ON)</sub>	Static Drain-to-Source ON-State Resistance			10	Ω	$V_{GS} = 0V$ , $I_D = 150mA$		
$\Delta R_{DS(ON)}$	Change in R <sub>DS(ON)</sub> with Temperature			1.1	%/°C	$V_{GS} = 0V, I_D = 150mA$		
G <sub>FS</sub>	Forward Transconductance	200			m&	I <sub>D</sub> = 100mA, V <sub>DS</sub> =10V		
C <sub>ISS</sub>	Input Capacitance			360		V <sub>GS</sub> = -5.0V, V <sub>DS</sub> = 25V, f =1.0Mhz		
C <sub>oss</sub>	Common Source Output Capacitance			40	pF			
C <sub>RSS</sub>	Reverse Transfer Capacitance			10				
t <sub>d(ON)</sub>	Turn-ON Delay Time			15		V <sub>DD</sub> = 25V,		
t,	Rise Time			20		I <sub>D</sub> = 150mA,		
t <sub>d(OFF)</sub>	Turn-OFF Delay Time			20	ns	$R_{GEN} = 25\Omega$ ,		
t <sub>f</sub>	Fall Time			30		V <sub>GS</sub> = 0V to -10V		
V <sub>SD</sub>	Diode Forward Voltage Drop			1.8	V	$V_{GS} = -5.0V, I_{SD} = 150mA$		
t <sub>rr</sub>	Reverse Recovery Time		800		ns	$V_{GS} = -5.0V, I_{SD} = 150mA$		

#### Notes:

- All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

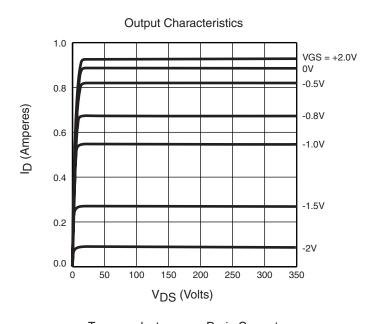
## **Switching Waveforms and Test Circuit**

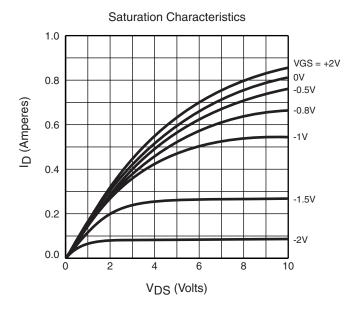


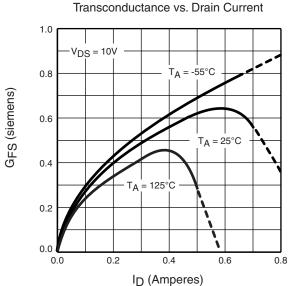


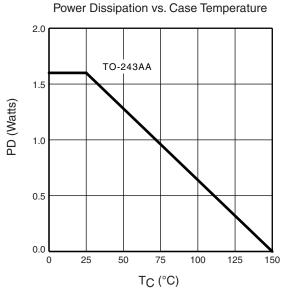
 $<sup>\</sup>star$  I<sub>D</sub> (continuous) is limited by max rated T<sub>j</sub>.  $\dagger$  Mounted on FR4 board, 25mm x 25mm x 1.57mm. Significant P<sub>D</sub> increase possible on ceramic substrate.

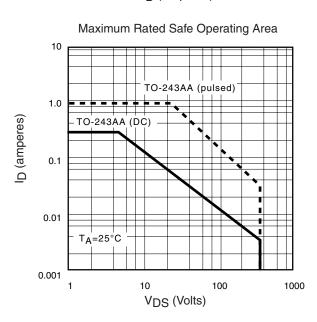
## **Typical Performance Curves**

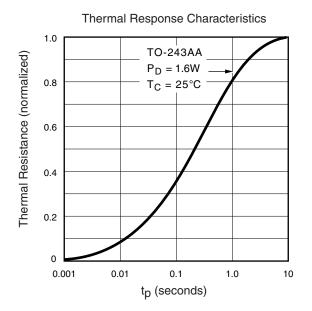




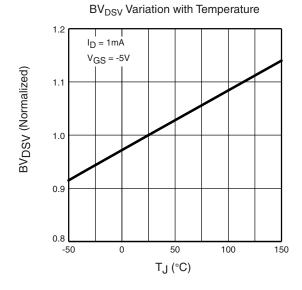


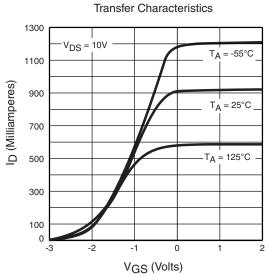


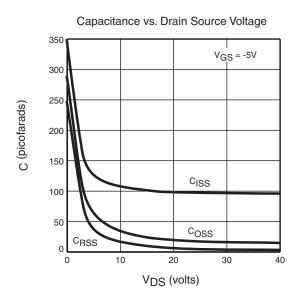


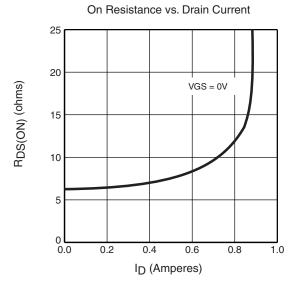


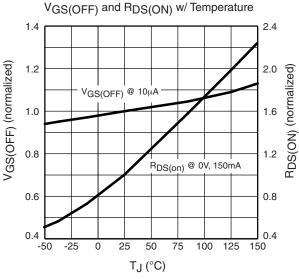
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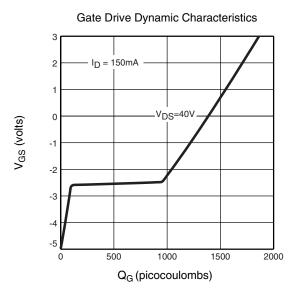












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